

Lead-Free Solder Paste

Melting Point	Specifications	Model	Weight	Packaging	Packaging	Mesh	Features	Scope of application	
217°C	Sn96.5Ag3Cu0.5	KZ-1354	500g		Bottle	20-38um	Lead-free and environmentally friendly, with smooth solder joints, easy to print, and no cold soldering issues.	Suitable for all welding.	
			200g						
217°C	Sn98.5Ag1Cu0.5	KZ-1354-B	200g/500g		Bottle	20-38um			
217°C	Sn99Ag0.3Cu0.7	KZ-1551	50g		Bottle	25-45um	Lead-free and environmentally friendly, with a high melting point.	SMT surface-mount technology, high-temperature resistant PCB board.	
			100g						
			200g						
			500g						
			30g		Syringe				
			50g						
			100g						

217°C	Sn99Ag0.3Cu0.7	KZ-1551A	200g		Bottle	20-38um		
			500g					
217°C	Sn99Ag1Cu0.5	KZ-1353C	200g		Bottle	20-38um		
			500g					

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Welding Temperature	Specifications	Model	Weight	Picture	Packaging	Mesh	Features	Scope of application
183°C	Sn55Pb45	K-539	500g		Bottle	25-45um	The LED patches do not easily shift, are less prone to solder cracking, offer high cost-effectiveness, and are economical and practical.	LED chip solder paste, suitable for LED lightbarsstrip lights, K-569A has superior welding performance compared to K-539.
183°C	Sn60Pb40	K-569A	500g		Bottle	25-45um		
183°C	Sn62.9Pb36.9Ag0.2	K-615B	500g		Bottle	20-38um	The solderability is superior to 6337 type, with full and shiny solder joints and minimal bridging.	Suitable for soldering QFN-type FCB assembly.

183°C	Sn63Pb37	K-735	500g		Bottle	25-45um	Strong soldering with minimal bridging, uniform and well-filled solder joints that are bright.	Suitable for 0.5mm pitch simple IC class PCB.
183°C	Sn63Pb37	K-735B	500g		Bottle	20-38um		Suitable for 0.4mm pitch fine-pitch IC class PCB.
			30g		Syringe			
			50g					
			100g					
183°C	Sn63Pb37	K-735C	500g		Bottle	15-30um	Suitable for 0.3mm pitch high-density IC type PCB.	
183°C	Sn62Pb36Ag2	K-635C	500g		Bottle	20-38um		
200g°C	SnPb	K-736	50g		Bottle	25-45um	High welding performance, convenience, sustainability.	Suitable for SMD, BGA, and other electronic liquid soldering.
			100g					
			200g					
			500g					

183°C	Sn62. 8Pb36. 8Ag 0. 4	K-635B	50g		Bottle	20-38um	Has better solderability than 615B, excellent conductivity, strong soldering, minimal bridging, and uniform full coverage.	Suitable for mobile phone repairs, BGA soldering, QFN, chip packaging, etc.
			100g					
			200g					
			500g					
			30g		Syringe			
			50g					
			100g					